

UNISONIC TECHNOLOGIES CO., LTD

6N40K-TA

Preliminary

Power MOSFET

TO-220

TO-220F1

6A, 400V N-CHANNEL POWER MOSFET

DESCRIPTION

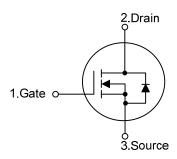
The UTC 6N40K-TA is an N-Channel enhancement mode power MOSFET using UTC's perfect planar stripe, DMOS technology to provide customers with superior switching performance and minimum on-state resistance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 6N40K-TA is generally used in applications, such as electronic lamp ballasts based on half bridge topology and high efficiency switched mode power supplies.

FEATURES

- * $R_{DS(ON)}$ <0.6 Ω @ V_{GS} =10V, I_{D} =3A
- * Fast switching speed
- * Improved dv/dt capability

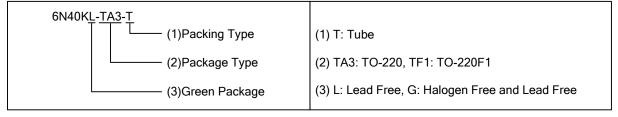
SYMBOL



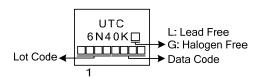
ORDERING INFORMATION

Ordering Number		Dealtone	Pin Assignment			Deaking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
6N40KL-TA3-T	6N40KG-TA3-T	TO-220	G	D	S	Tube	
6N40KL-TF1-T	6N40KG-TF1-T	TO-220F1	G	D	S	Tube	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



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■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	400	V
Gate-Source Voltage		V_{GSS}	±30	V
Avalanche Current (Note 2)		I _{AR}	6	Α
Drain Current	Continuous	I _D	6 (Note 5)	Α
	Pulsed (Note 2)	I _{DM}	24(Note 5)	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	240	mJ
	Repetitive (Note 2)	E _{AR}	8.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns
D. Division(in	TO-220	1	73	107
Power Dissipation	TO-220F1	P _D	38	W
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L=13.5mH, I_{AS} =6A, V_{DD} = 50V, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C
- 4. $I_{SD} \le 6A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$
- 5. Drain current limited by maximum junction temperature

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	TO-220/TO-220F1	θ_{JA}	62.5	°C/W
Junction to Case	TO-220	0	1.71	°C/A/
	TO-220F1	$\theta_{\sf JC}$	3.31	°C/W

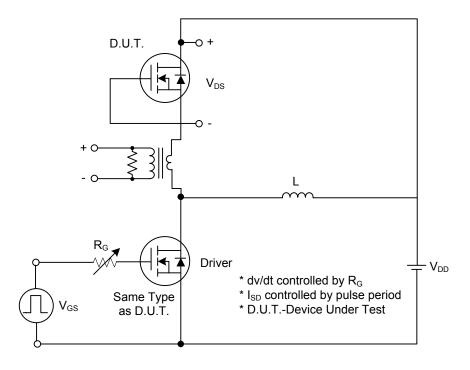
■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} =0V, I _D =250μA	400			V
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_{J}$	I _D =250μA, Referenced to 25°C		0.54		V/°C
Drain-Source Leakage Current		I _{DSS}	V _{DS} =400V, V _{GS} =0V V _{DS} =320V, T _J =125°C			1 10	μA μA
Gate-Source Leakage Current Forward Reverse		I _{GSS}	V _{DS} =0V ,V _{GS} =+30V V _{DS} =0V ,V _{GS} =-30V			+100	nA nA
ON CHARACTERISTICS		l.	, ==	1	l	l	
Gate Threshold Voltage		$V_{GS(TH)}$	V _{DS} =V _{GS} , I _D =250μA	2.0		4.0	V
Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =3A			0.6	Ω
DYNAMIC PARAMETERS				_			_
Input Capacitance		C _{ISS}			490		pF
Output Capacitance		Coss	V_{DS} =25V, V_{GS} =0V,f=1.0MHz		95		pF
Reverse Transfer Capacitance		C _{RSS}			8.4		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	V _{DS} =50V, V _{GS} =10V, I _D =1.3A		65		nC
Gate-Source Charge		Q_{GS}	(Note 1,2)		6.2		nC
Gate-Drain Charge		Q_{GD}	(140te 1,2)		8.8		nC
Turn-ON Delay Time		t _{D(ON)}			60		ns
Turn-ON Rise Time		t _R	V_{DD} =30V, I_{D} =0.5A, R_{G} =25 Ω		65		ns
Turn-OFF Delay Time		t _{D(OFF)}	V _{GS} =10V (Note 1,2)		105		ns
Turn-OFF Fall Time		t _F			44		ns
SOURCE- DRAIN DIODE RATING	S AND C	HARACTERI	STICS				
Maximum Body-Diode Continuous (Current	I _S				6	Α
Maximum Body-Diode Pulsed Current		I _{SM}				24	Α
Drain-Source Diode Forward Voltage		V_{SD}	I _S =6A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time		t _{rr}	V _{GS} =0V, I _S =6A, V _R =50V		300		ns
Body Diode Reverse Recovery Charge		Q_{RR}	dI _F /dt=100A/μs (Note 1)		1.75		μC

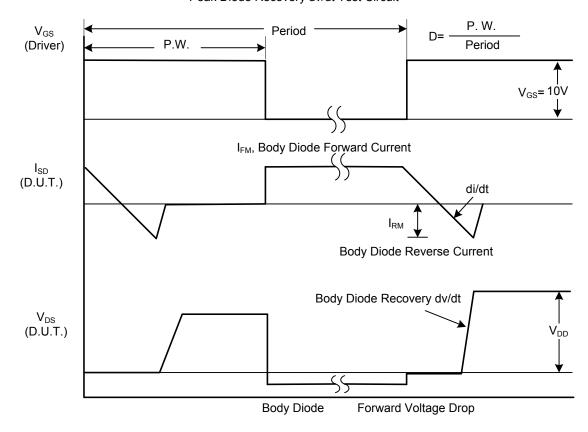
Notes: 1. Pulse Test : Pulse width ≤ 300µs, Duty cycle ≤ 2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

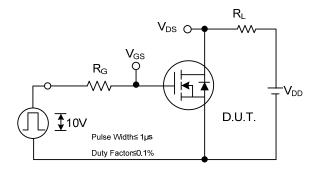


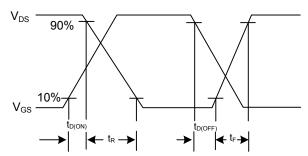
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

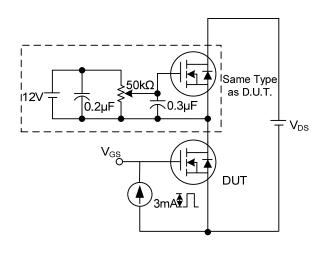
■ TEST CIRCUITS AND WAVEFORMS(Cont.)

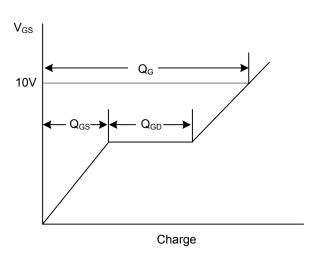




Switching Test Circuit

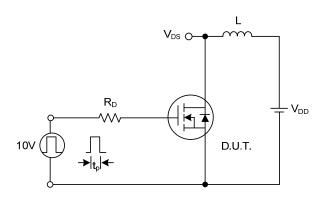
Switching Waveforms

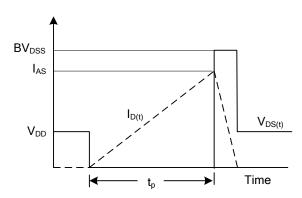




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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